BLF6G20LS-140

Power LDMOS transistor

Rev. 2 — 1 September 2015



1. Product profile

1.1 General description

140 W LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2000 MHz.

Table 1.Typical performance

RF performance at $T_{case} = 25 \ ^{\circ}C$ in a common source class-AB production test circuit.

Mode of operation	f	V_{DS}	P _{L(AV)}	Gp	η_D	IMD3	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)	(dBc)
2-carrier W-CDMA	1930 to 1990	28	35.5	16.5	30	-37 <mark>[1]</mark>	-40 <mark>[1]</mark>

 Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7 dB at 0.01 % probability on CCDF per carrier; carrier spacing 10 MHz.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

- Typical 2-carrier W-CDMA performance at frequencies of 1930 MHz and 1990 MHz, a supply voltage of 28 V and an I_{Dq} of 1000 mA:
 - Average output power = 35.5 W
 - Power gain = 16.5 dB (typ)
 - Efficiency = 30 %
 - ◆ IMD3 = -37 dBc
 - ♦ ACPR = -40 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1800 MHz to 2000 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

RF power amplifiers for GSM, GSM EDGE, W-CDMA and CDMA base stations and multi carrier applications in the 1800 MHz to 2000 MHz frequency range

2. Pinning information

Pin	Description		Simplified outline	Graphical symbol
1	drain			
2	gate			1 لــــا
3	source	<u>[1]</u>	2	2 – – – – – – – – – – – – – – – – – – –

[1] Connected to flange.

3. Ordering information

Table 3. Ordering inf	ormation
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Type number	Package		
	Name	Description	Version
BLF6G20LS-140	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		-0.5	+13	V
I _D	drain current		-	39	А
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	225	°C

5. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-case)}	thermal resistance from junction to case	T_{case} = 80 °C; P_L = 35 W	0.49	K/W

Characteristics 6.

Table 6. <i>T_j</i> = <i>25 ℃</i>	Characteristics <i>Cunless otherwise specified.</i>					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.5 mA	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	V_{DS} = 10 V; I _D = 216 mA	1.4	2	2.4	V
V_{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 1000 mA	1.53	2	2.53	V
I _{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 28 V	-	-	5	μA
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	31	39	-	А
I _{GSS}	gate leakage current	V _{GS} = 13 V; V _{DS} = 0 V	-	-	450	nA
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 10.8 A	9.7	13.5	15	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 7.56 A$	-	0.07	-	Ω
C _{rs}	feedback capacitance	V _{GS} = 0 V; V _{DS} = 28 V; f = 1 MHz	-	3.57	-	pF

Application information 7.

Table 7. **Application information**

Mode of operation: 2-carrier W-CDMA; PAR 7 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH; f₁ = 1932.5 MHz; f₂ = 1942.5 MHz; f₃ = 1977.5 MHz; f₄ = 1987.5 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 1000 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

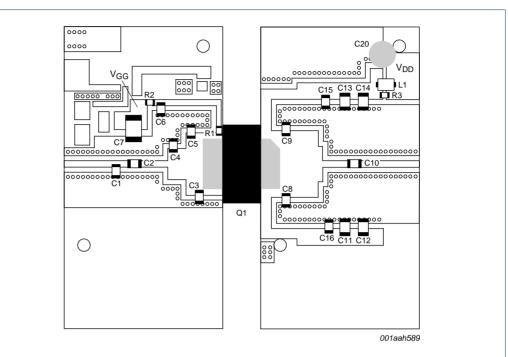
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	35.5	-	W
G _p	power gain	P _{L(AV)} = 35.5 W	15.5	16.5	-	dB
RL _{in}	input return loss	P _{L(AV)} = 35.5 W	-	8	5	dB
η_D	drain efficiency	P _{L(AV)} = 35.5 W	27	30	-	%
IMD3	third order intermodulation distortion	P _{L(AV)} = 35.5 W	-	-37	-35	dBc
ACPR	adjacent channel power ratio	P _{L(AV)} = 35.5 W	-	-40	-38	dBc

7.1 Ruggedness in class-AB operation

The BLF6G20LS-140 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Da} = 1000 mA; P_L = 140 W (CW); f = 1990 MHz.

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8. Test information



The striplines are on a double copper-clad Taconic RF35 Printed-Circuit Board (PCB) with ε_r = 3.5 and thickness = 0.76 mm. See Table 8 for list of components.

Fig 1. Component layout

Table 8. List of components (see Figure 1)

Component	Description	Value		Remarks
C1	multilayer ceramic chip capacitor	0.5 pF	[1]	
C2	multilayer ceramic chip capacitor	10 pF	[2]	
C3	multilayer ceramic chip capacitor	0.9 pF	[2]	
C4	multilayer ceramic chip capacitor	1.1 pF	[2]	
C5	multilayer ceramic chip capacitor	1.4 pF	[2]	
C6	multilayer ceramic chip capacitor	15 pF	[2]	
C7	multilayer ceramic chip capacitor	10 μF; 50 V		TDK C5750X7R1H106M or equivalent
C8, C9	multilayer ceramic chip capacitor	1.2 pF	[2]	
C10	multilayer ceramic chip capacitor	13 pF	[2]	
C11, C12, C13, C14	multilayer ceramic chip capacitor	4.7 μF; 50 V		TDK C4532X7R1H475M or equivalent
C20	electrolytic capacitor	220 μF; 35 V		
L1	ferrite SMD bead	-		Ferroxcube BDS 3/3/8.9-4S2 or equivalent
Q1	BLF6G20LS-140	-		
R1	SMD resistor	0 Ω		
R2	SMD resistor	3.3 kΩ		
R3	SMD resistor	9.1 Ω		

[1] American Technical Ceramics type 100A or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

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9. Package outline

Earless flanged ceramic package; 2 leads

SOT502B

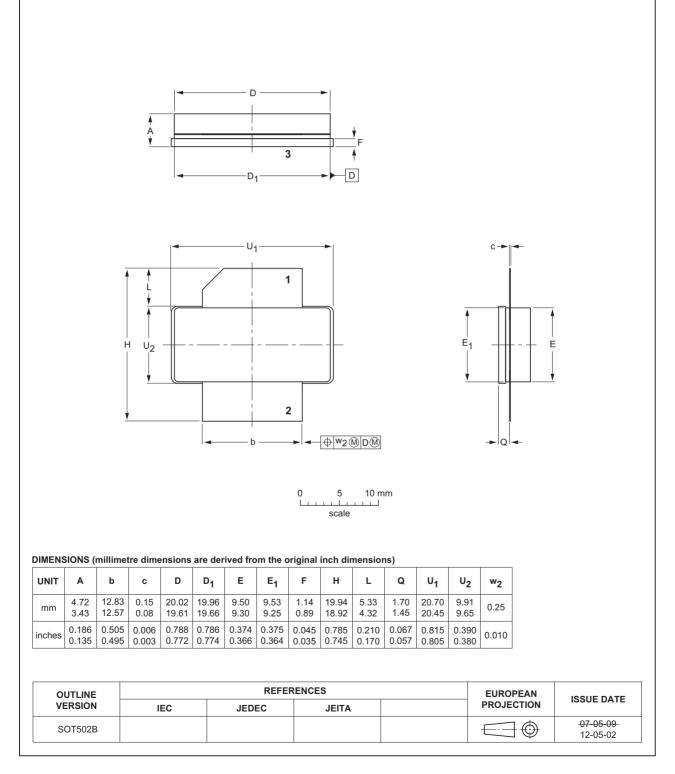


Fig 2. Package outline SOT502B

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10. Abbreviations

Table 9.	Abbreviations	
Acronym		Description
3GPP		Third Generation Partnership Project
CCDF		Complementary Cumulative Distribution Function
CDMA		Code Division Multiple Access
CW		Continuous Wave
DPCH		Dedicated Physical CHannel
EDGE		Enhanced Data rates for GSM Evolution
GSM		Global System for Mobile communications
LDMOS		Laterally Diffused Metal Oxide Semiconductor
LDMOST		Laterally Diffused Metal-Oxide Semiconductor Transistor
PAR		Peak-to-Average power Ratio
PDPCH		transmission Power of the Dedicated Physical CHannel
RF		Radio Frequency
SMD		Surface Mounted Device
VSWR		Voltage Standing Wave Ratio
W-CDMA		Wideband Code Division Multiple Access

11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF6G20LS-140#2	20150901	Product data sheet	-	BLF6G20LS-140_1
Modifications:	• The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.			
	 Legal texts have been adapted to the new company name where appropriate. 			
BLF6G20LS-140_1	20090227	Product data sheet	-	-

12. Legal information

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Document status ^{[1][2]}	Product status ^[3]	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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